TRANSMITTAL LETTER TO THE UNITED STATES DESIGNATED/FILECTED OFFICE (DO/EO/US) CONCERNING A FILING UNIDER 35 U.S.C. 371 PCT/US00/11303 27 Apr.1 2000 PCT/US00/11303 27 Apr.1 2000 PCT/US00/11303 27 Apr.1 2000 PCT/US00/11303 PCT/US00/113033 PCT/US00/11303 PCT/US00/11303 PCT/US00/11303 PCT/US00/11303 PCT/US0	6.0		10 - 65	JCO7 Recapetall 2 6 UCHANN
PRETENATIONAL APPLICATION NO. INTERNATIONAL FILING DATE PRIORITY DATE CLAIMED PCT/US00/11303	2 6 2	TRANSMITTAL LETTER DESIGNATED/ELECT	R TO THE UNITED ST TED OFFICE (DO/EO/I	ATES PSS 2 0066 US APPLICATION NO (If known, see 37 CFR 1.5
APPLICANT(S) FOR DO/EO/LS CECH Steven, D. Applicant herewith submits to the United States Designated/Elected Office (DO/EO/US) the following items and other information: 1. ☑ This is a FIRST submission of items concerning a filing under 35 U.S.C. 371. 2. ☐ This is an express request to begin national examination procedures (35 U.S.C. 371(n)). The submission must include items (3), (6), 9 and (21) indicated below. 4. ☐ The US has been elected by the expiration of 19 months from the priority date (Article 31). 5. ☑ A copy of the International Application as filed (35 U.S.C. 371(c)/2)) a. ☐ is attached hereto (required only if not communicated by the International Bureau). b. ☐ has been communicated by the International Application as filed (35 U.S.C. 371(c)/2)). a. ☐ is attached hereto. b. ☐ has been previously submitted under 35 U.S.C. 154(d)(4). 7. ☑ Amendments to the claims of the International Application under PCT Article 19 (35 U.S.C. 371(c)(2)). a. ☐ is attached hereto. b. ☐ have been communicated by the International Bureau. c. ☐ have not been made; however, the time limit for making such amendments has NOT expired. d. ☑ have not been made and will not be made. 8. ☐ An English language translation of the amendments to the claims under PCT Article 19 (35 U.S.C. 371 (c)(3)). 9. ☐ An english language translation of the amendments to the claims under PCT Article 19 (35 U.S.C. 371 (c)(3)). 10. ☐ An English language translation of the amendments to the claims under PCT Article 19 (35 U.S.C. 371 (c)(3)). 11. ☐ An English language translation of the amendments to the claims under PCT Article 19 (35 U.S.C. 371 (c)(3)). 12. ☐ An assignment document for recording. A separate cover sheet in compliance with 37 CFR 3.28 and 3.31 is included. 13. ☐ A FIRST preliminary amendment. 14. ☐ A change of power of attorney and/or address letter. 15. ☐ A second copy of the English language translation of the international application under 35 U.S.C. 154(d)(4). 18. ☐ A second copy of the English language t	ADE	ATTERNATIONAL APPLICATION NO. PCT/US00/11308	INTERNATIONAL FILING	DATE PRIORITY DATE CLAIMED 29 April 1999
Commissioner of Patents and Trademarks, Washington, DC 20231. (TYPED OR PRINTED NAME OF SENDER)	PADE	PCT/US00/11308 TITLE OF INVENTION SYSTEM INTEGRITY OF VISIBLY APPLICANT(S) FOR DO/EO/US Applicant herewith submits to the United St. 1.	AND METHOD FOR INCLEAR OBJECTS CH, Steven, D. Tates Designated/Elected Office (1) Is concerning a filing under 35 U. INT submission of items concernitational examination procedures (1) Into as filed (35 U.S.C. 371(c)(2) Id only if not communicated by the International Bureau. Ilication was filed in the United St. International Application as filed under 35 U.S.C. 154(d)(4). Iternational Application under PCT and only if not communicated by the International Bureau. International Application under PCT and only if not communicated by the International Bureau. International Application under PCT and only if not communicated by the International Bureau. International Application under PCT and International Public (1) International Application included: International A	NSPECTING THE STRUCTURAL DO/EO/US) the following items and other information: S.C. 371. Ing a filing under 35 U.S.C. 371. 35 U.S.C. 371(f)). The submission must include prity date (Article 31). Ing a filing under 35 U.S.C. 371. Article 19 (35 U.S.C. 371(c)(2)). Article 19 (35 U.S.C. 371(c)(3)). Article 19 (35 U.S.C. 371(c)(3)) The International Bureau). Chamendments has NOT expired. The PCT Article 19 (35 U.S.C. 371 (c)(3)). The International Bureau in the Intern

09 4010 Recid PCT/HTO5 1216 100 2001

09/98[J851" P	CT/US00/11308			PSS 2 00	KET NUMBER 066
	ving fees are submitted:			CAL	CULATIONS	PTO USE ONLY
	L FEE (37 CFR 1.492 (a					
Neither international preliminary examination fee (37 CFR 1.482) nor international search fee (37 CFR 1.445(a)(2)) paid to USPTO and International Search Report not prepared by the EPO or JPO						
International prelin USPTO but Intern	ninary examination fee ational Search Report p	(37 CFR 1.482) not paid trepared by the EPO or JPO	0			
International prelimental but international se	ninary examination fee earch fee (37 CFR 1.445	(37 CFR 1.482) not paid to (a)(2)) paid to USPTO	o USPTO \$710.00			
but all claims did n	ot satisfy provisions of	(37 CFR 1.482) paid to US PCT Article 33(1)-(4)	\$690.00			
and all claims satis	fied provisions of PCT	(37 CFR 1.482) paid to US Article 33(1)-(4)	\$100.00		·	T
		BASIC FEE AMO	UNT =	\$ 1	00.00	
months from the ear	liest claimed priority da	or declaration later than te (37 CFR 1.492(e)).	20 30	\$		
CLAIMS	NUMBER FILED	NUMBER EXTRA	RATE	\$		
Total claims Independent claims	34 -20 =	14	x \$18.00		52.00	
	$\frac{2}{\text{DENT CLAIM(S) (if ap)}}$		x \$80.00	\$		
MOETH EE DEI EN		OF ABOVE CALCU	+ \$270.00	\$ \$ 3	52.00	
X Applicant claim	is small entity status. Se	e 37 CFR 1.27. The fees	indicated above			
are reduced by	1/2.		+		76.00	
Drocessing for of \$1	20 00 for furnishing the		UBTOTAL =	\$ 1	76.00	
months from the earl	liest claimed priority dat			\$		
		TOTAL NATIO		\$		
ree for recording the accompanied by an a	enclosed assignment (3 appropriate cover sheet (37 CFR 1.21(h)). The assi 37 CFR 3.28, 3.31). \$40.	gnment must be 00 per property +	\$	40.00	
\$ ²		TOTAL FEES E	NCLOSED =	\$ 2	16.00	-
					int to be efunded:	\$
-					charged:	\$
a. A check in the amount of \$ 176.00 to cover the above fees is enclosed. X A check in the amount of \$40.00 is enclosed. b. Please charge my Deposit Account No						
NOTE: Where an appropriate time limit under 37 CFR 1.494 or 1.495 has not been met, a petition to revive (37 CFR 1.137 (a) or (b)) must be filed and granted to restore the application to pending status. SEND ALL CORRESPONDENCE TO: Richard J. Minnich Fay, Sharpe, Fagan, Minnich & McKee, LLP 1100 Superior Avenue 7th Floor Cleveland, OH 44114-2518 Richard J. Minnich NAME 24,175						
			REGISTRA		JMBER	

SYSTEM AND METHOD FOR INSPECTING THE STRUCTURAL INTEGRITY OF VISIBLY CLEAR OBJECTS

Field of the Invention

This application pertains to the art of inspecting the structural integrity of visibly clear objects. In particular, it relates to the inspection of visibly clear food and/or beverage containers manufactured out of glass or plastic. Though the invention will be described with reference to those items, it should be understood that the invention has a broader application to the inspection of any manufactured or naturally occurring object having a predominately visibly-clear structure.

Background of the Invention

Machine vision systems providing some degree of functionality related to inspecting the structural integrity of visibly clear glass and/or plastic containers have been conceived and constructed. Generally, such systems are based on the operation of an area array sensor, most typically a CCD sensor, sensitive to energy in the visible portion of the electromagnetic spectrum (400nm to 700nm). For purposes of this disclosure, the term visibly clear specifically means that the material allows very high optical transmission of electromagnetic radiation (light) falling within the 400nm to 700nm visible wavelength range.

One fairly obvious but important fact associated with objects manufactured from visibly clear material is that it is difficult, using state-of-the-art machine vision techniques, to inspect such objects for the presence of material voids in their final formed structure. This is significant because material voids such as holes or cracks are critical part defects which compromise the intended function of the product.

Machine vision inspection systems typically operate by measuring the spatial variations of visible light as it reflects off or transmits through the structure. Since the objects which are to be inspected by such state-of-the-art systems are predominately clear in nature, the spatial light intensity variations which result from the presence of material voids in the material structure are quite

5

10

15

20

5

10

15

20

25

30

small and result in less than adequate overall system performance. Stated in other words, holes and cracks in visibly clear objects are hard to see using machine vision systems operating within the visible region of the electromagnetic spectrum.

Another attribute of current state-of-the-art inspection systems is that they require a great deal of special purpose hardware and software in order to provide any level of product inspection. Light sources, imaging optics, cameras, control electronics, and an image processing computer executing custom inspection algorithms are required for baseline system functionality. This collection of hardware and software components result in an expensive inspection solution which, in many structural inspection applications, falls short of desired performance requirements.

The subject invention overcomes the problems of limited inspection performance and high cost by providing a sensor system operating at infrared wavelengths wherein the object under inspection is naturally opaque.

Summary of the Invention

In accordance with one aspect of the present invention, there is provided an inspection system comprising at least one detection element sensitive to electromagnetic radiation at a wavelength wherein the object to be inspected is rendered opaque by naturally occurring material molecular (and/or atomic) absorptions. In the disclosed invention, the discrete detection element or detector is positioned at an advantageous location wherein a transport mechanism (either a transport mechanism naturally associated with the manufacturing process or one specifically designed for the purpose of presenting the object to the inspection station) moves the object to be inspected into close proximity to the detection element to accommodate structural inspection. When the object is positioned for inspection, a source of infrared radiation containing a significant component of its emitted energy at wavelengths wherein visibly clear objects become generally opaque is disposed opposite of the detector. Properly positioned, the transported object under inspection passes through the detector/IR source line of sight. So positioned, the detector/IR radiation source components comprise a simple system capable of robustly detecting material voids occurring in the objects under

inspection.

5

10

15

20

25

30

In accordance with a more limited aspect of the disclosed invention, the infrared radiation source is chopped (e.g. mechanically or electrically) at a known time-based frequency to aid in the detection of the transmitted IR signal.

Further scope of the applicability of the present invention will become apparent from the detailed description provided below. It should be understood, however, that the detailed description and specific examples, while indicating preferred embodiments of the invention, are given by way of illustration only, since various changes and modifications within the spirit and scope of the invention will become apparent to those skilled in the art.

Brief Description of the Drawings

The present invention exists in the construction, arrangement and combinations of the various parts of the device and/or the steps of the method whereby the objects contemplated are attained as hereinafter more fully set forth in the detailed description and illustrated in the accompanying drawings in which:

FIGURES 1(a) and (b) illustrate a system according to the present invention;

FIGURE 2 shows the transmission spectrum for a sample of PET material; and,

FIGURE 3 is a flowchart according to the present invention.

Description of the Preferred Embodiment

One parameter often used to both qualitatively and quantitatively describe various materials is an optical attribute referred to as an optical transmission property. In laymen's terms, this parameter describes the ability of a material to allow visible light (that limited portion of the electromagnetic spectrum between 400nm and 700nm) to transmit therethrough. Materials which exhibit no tendency to absorb light in the visible wavelength range are defined as visibly clear materials. Glass, PET, and PEN are examples of visibly clear materials.

The above-referenced material parameter, or property, called optical transmission can be more broadly defined as the reaction of the material to

5

10

15

20

25

30

electromagnetic radiation in a wavelength range extending beyond the visible spectrum. For many reasons, it is more useful to consider the wavelength range extending from 400nm in the visible region out to 15um in the infrared region in the qualitative definition of the optical transmission characteristics of the material. In this regard, the techniques of geometric optics apply equally well to this broader wavelength region. In addition, there are radiation sources, detectors, and optical materials and coatings commercially available for use in this broader wavelength region making it feasible to theorize and construct optical instrumentation to sense and quantify optical radiation in this broader wavelength region. When characterized over this broader range, most materials which are highly transmissive in the visible wavelength range exhibit large regions of low and even zero transmission of electromagnetic radiation in other portions of the electromagnetic spectrum.

In much of the electromagnetic spectrum, the visibly clear materials used in the construction of food and beverage containers are completely opaque to incident radiation. The subject invention takes advantage of this material phenomenon under the pretext that it will be advantageous to look for the presence of holes, cracks, or other material voids in a wavelength region wherein the material is opaque as opposed to performing the same inspection operation at wavelengths wherein the material itself is predominately clear, as is done in current inspection systems.

Referring now to the drawings wherein the figures are for the purpose of illustrating the preferred embodiments of the invention only, and not for the purpose of limiting the same, Figure 1(a) represents an overall view of an inspection system according to the present invention. As shown, a transport mechanism 40 is utilized to position visibly clear plastic or glass articles 10 within an inspection zone 80. The transport mechanism may be a conveyor or any other suitable device or arrangement to facilitate the inspection of an object in the zone. In addition, as should be apparent to those skilled in the art, sufficient support structure, including the transport or conveyor mechanism, is provided to the system to support the source and sensor device as well as maintain the object under inspection in proper position for inspection.

In the position shown in zone 80, the object 10 under inspection is positioned within the line of sight between a detector 60 and an infrared source 20. So positioned, a specific portion of the object is subject to inspection for the presence of material voids. In the case of the preferred embodiment, the base portion of the visibly clear container can be inspected for cracks or holes using the disclosed invention. Of course, it is to be appreciated that other portions of the objects may be inspected. Moreover, it is contemplated that objects other than containers can also be inspected.

5

10

15

20

25

30

More particularly, when in the inspection zone 80, the object under inspection 10 is positioned in the line of sight between the radiation source 20 and the detector 60. The radiation source is chosen based on its ability to emit significant energy at optical wavelengths wherein the object under inspection 10 is generally opaque. For many visibly clear materials including glass, PET, and PEN, the wavelength region above 3um contains many broad hydrocarbon-based absorption bands which severely limit optical transmission. This behavior is depicted in Figure 2 -- which shows the transmission spectrum of PET from 2um out to 25um. The visible spectrum, not shown, corresponds to 0.4 - 0.7um (or 400-700nm). The large regions where the transmission dips to 0% indicates regions where the material is opaque. The preferred source of IR radiation at these longer wavelengths is a black body or gray body thermal radiator operating at temperatures up to about 1000°C. In addition to black body radiation sources, there exist commercially available solid-state emitters (e.g. LEDs), which may be arranged in arrays, operating at wavelengths of approximately 3um and above which would be applicable to the subject invention. It will be appreciated that the selection of an infrared source will depend largely on the desired wavelength of operation.

Referring back now to Figure 1, to detect and respond to the emitted infrared radiation produced by source 20, a detector 60 needs to be chosen which has a high sensitivity to incident radiation above 3um. There are many potentially suitable single or plural element detector types which could be utilized in the subject invention including Mercury Cadmium Telluride (MCT), Lead Sulfide (PbS), Indium Antimonide (InSb), and Lead Selenide (PbSe). In more general

terms, these specific detector types can be described as either photoconductive, photovoltaic, or thermal detector types. Further, it should be appreciated that the detector 60 may also be a suitable camera or any other sensor device that may comprise a one or two dimensional array of photosensitive elements.

5

To improve the ability of the system to detect small material voids, a chopping mechanism 30 is applied to the energy emitted by the radiation source 20 prior to interacting with the object 10 under test. Such mechanisms are well known in the thermal infrared imaging field. This concept is also similar to the one used to encode and decode AM radio transmissions.

10

In the preferred embodiment, the system chopper 30 is a mechanical chopper that takes the exemplary form of a rotating disk with alternating opaque/transparent regions which act to modulate the energy emitted by the radiation source 20, as is well known and illustrated in Figure 1(b). In this fashion, the signal of interest is isolated to a specific time-based frequency (the chopping frequency) which facilitates the measurement of low level signals incident on the detector 60.

15

Alternatively, an electronic, or electrical, chopper may be used. For example, a pulsed infrared source (e.g. pulsed LEDs) may be used wherein the pulsing corresponds to the physical modulating of energy by the application of pulsed drive current.

20

In either the mechanical chopper or electronic chopper, the advantage of use is that the detector is able to better detect the signal of interest. In this regard, the signal to noise ratio of subsequently received signals is increased. In the preferred embodiment, the signal of interest corresponds to the energy that passes through a crack or void in the bottom of a container 10.

25

Completing the preferred embodiment of the subject invention are a control electronics module 70 and a part reject mechanism 50. These mechanisms and associated systems are well known in the inspection art. Briefly, however, the control electronics module (or processor comprising various hardware and software configurations) 70 provides power and detector bias signals to the detector 60. In return, it receives inspection information related to the objects structural integrity from the detector 60. From this output, the module 70 is able to determine a state,

quality, or acceptability of objects under inspection. It then selectively uses this information to operate a reject mechanism 50 in a pass/fail mode. The reject mechanism may act to physically reject or otherwise mark for subsequent action objects determined to be out of, or alternatively, within specifications as previously standardized and encoded within the processor module 70. Moreover, in systems whereby the objects being inspected are formed in mold cavities within the system, part rejection information will also be useful to correlate and feedback to the molding components to possibly effect adjustments and corrections. Furthermore, it should be recognized that well-known, conventional machine vision and/or inspection systems typically have incorporated therein part detection devices (such as element 45 in Figure 1), tracking features and conveyance mechanisms and systems (such as transport mechanism 40) that are deployed to interact with the objects under inspection and used to maneuver the objects under inspection into an advantageous position between the sensor and the source as well as provide instrument control signals to both the sensor and the source.

It should be readily apparent from the detailed description above, that in operation, the system of the present invention accomplishes the method of Figure 3 as follows. First, a visibly clear object is placed or conveyed to a position between a sensing device and an electromagnetic source (step 302). Next, electromagnetic radiation is generated by the source in wavelength ranges to render the objects under inspection opaque (step 304). The radiation is then sensed at these wavelengths, which correspond to the opaque wavelength regions of the objects under inspection (step 306). A state, quality or acceptability is then determined based on the sensing (step 308). In addition, other features of the invention as described above may be embodied in this method. For example, the generating step may include pulsing the source means to increase a signal to noise ratio of a subsequentially received electromagnetic signal.

This invention has been described with reference to the preferred embodiment. Obvious modifications and alterations will occur to others upon reading and understanding the specifications. It is intended that all such modifications and alterations be included insofar as they come within the scope of the appended claims or equivalents thereof.

Having just described the invention, we claim:

5

10

5

1. A sensing apparatus useful for inspecting the structural integrity of visibly clear objects, the apparatus comprising:

a sensor device operative to respond to electromagnetic radiation at one or more wavelengths or wavelength ranges corresponding to electromagnetic energy transmission wherein the objects are rendered opaque by naturally occurring molecular and/or atomic absorptions occurring within material comprising the objects;

an electromagnetic radiation source wherein a significant portion of an emitted spectrum therefrom occurs in the ranges wherein the objects are generally opaque; and,

a support structure positioned to support the sensor device and source and to maintain the objects in between the source and the sensor device.

- 2. The apparatus of claim 1 wherein the sensor device is comprised of a single-element photoconductive, photovoltaic, or thermal detector.
- 3. The apparatus of claim 2 further comprising a processor operative to receive an output of the sensor device and operate on the output to determine the state, quality, or acceptability of the objects.
- 4. The apparatus of claim 3 further comprising part detection, tracking, and conveyance systems deployed to interact with the objects and used to both maneuver the object under test into an advantageous position between the sensor element and the source and to provide instrument control signals to both the sensor device and the source.
- 5. The apparatus of claim 4 further comprising a reject system which receives the processed output of the processor and acts to physically reject or otherwise mark for subsequent action objects.

6. The apparatus of claim 5 wherein the source comprises a black or gray body thermal emitter.

- 7. The apparatus of claim 6 wherein the source is amplitude modulated by a mechanical chopping system in order to increase a signal to noise ratio of a subsequently received electromagnetic signal.
- 8. The apparatus of claim 5 wherein the source comprises a semiconductor LED type emitter or array of emitters.
- 9. The apparatus of claim 8 wherein the source is pulsed in order to increase a signal to noise ratio of a subsequently received electromagnetic signal.
- 10. The apparatus of claim 1 wherein the sensor device is comprised of a one or two-dimensional array of photosensitive elements.
- 11. The apparatus of claim 10 further comprising a processor which receives the output of the sensor device and operates on the output to determine the state, quality, or acceptability of the objects.
- 12. The apparatus of claim 11 further comprising part detection, tracking, and conveyance systems deployed to interact with the objects and used to both maneuver the object under test into an advantageous position between the sensor device and source and to provide instrument control signals to both the sensor device and source.

- 13. The apparatus of claim 12 further comprising a reject system which receives the processed output of the processor and acts to physically reject or otherwise mark for subsequent action objects.
 - 14. The apparatus of claim 13 wherein the source comprises a black or

gray body thermal emitter.

5

10

15. The apparatus of claim 14 wherein the source is amplitude modulated by a mechanical chopping system in order to increase a signal to noise ratio of a subsequently received electromagnetic signal.

- 16. The apparatus of claim 15 wherein the source comprises a semiconductor LED type emitter or array of emitters.
- 17. The apparatus of claim 16 wherein the source is pulsed in order to increase a signal to noise ratio of a subsequently received electromagnetic signal.
- 18. A sensing method wherein visibly clear objects are inspected for structural integrity, the method comprising steps of:

placing a visibly clear object under test disposed in between a sensor device and a source of electromagnetic radiation;

generating electromagnetic radiation in wavelength ranges such that the objects are substantially opaque due to naturally occurring molecular or atomic absorptions occurring in material comprising the objects, the ranges corresponding to both the opaque wavelength regions of the objects and sensitivity regions of the sensing device;

sensing with the sensor device the electromagnetic radiation at the wavelengths which correspond to the opaque wavelength regions of the objects under test; and,

determining a state, quality, or acceptability of the objects based on an output of the sensor device.

- 19. The method of claim 18 wherein the sensing comprises using a single-element photoconductive, photovoltaic, or thermal detector.
- 20. The method of claim 19 further comprising using processing means to receive output of the sensor device and to operate on the output to determine a

state, quality, or acceptability of the objects.

- 21. The method of claim 20 further comprising using part detection, tracking, and conveyance systems deployed to interact with the objects and useful to both maneuver the objects into an advantageous position between the sensor device and a source of the electromagnetic radiation and to provide instrument control signals to both the sensor device and the source.
- 22. The method of claim 21 further comprising using a reject system to receive processed output of the processing means and to physically reject or otherwise mark objects.
- 23. The method of claim 22 wherein the generating comprising using a black or gray body thermal emitter.
- 24. The method of claim 23 wherein the generating comprises amplitude modulating the radiation by a mechanical chopping system in order to increase a signal to noise ratio of a subsequently received electromagnetic signal.
- 25. The method of claim 22 wherein the generating comprises using a semiconductor LED type emitter or array of emitters.
- 26. The method of claim 25 further comprising pulsing the source in order to increase a signal to noise ratio of a subsequently received electromagnetic signal.
- 27. The method of claim 18 wherein the sensing comprising using a one or two-dimensional array of photosensitive elements.
- 28. The method of claim 27 further comprising using processing means to receive the output of the sensor device and to operate on the output to determine a state, quality, or acceptability of the objects.

5

29. The method of claim 28 further comprising using part detection, tracking, and conveyance means deployed to interact with the objects and useful to both maneuver the objects into an advantageous position between the sensor device and a source of electromagnetic radiation and to provide instrument control signals to both the sensor device and the source.

- 30. The method of claim 29 further comprising using a reject system to receive processed output of the processing means and to physically reject or otherwise mark objects.
- 31. The method of claim 30 wherein the generating comprises using a black or gray body thermal emitter.
- 32. The method of claim 31 wherein the generating comprises using a mechanical chopping system to amplitude modulate in order to increase a signal to noise ratio of a subsequently received electromagnetic signal.
- 33. The method of claim 32 wherein the generating comprises using a semiconductor LED type emitter or array of emitters.
- 34. The method of claim 33 wherein the generating comprises pulsing to increase a signal to noise ratio of a subsequently received electromagnetic signal.



(30) Priority Data:





INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

(51) International Patent Classification 7:

B07C 5/34

(11) International Publication Number: WO 00/66283

(43) International Publication Date: 9 November 2000 (09.11.00)

(21) International Application Number: PCT/US00/11308

(22) International Filing Date: 27 April 2000 (27.04.00)

60/131,561 29 April 1999 (29.04.99) US

(71) Applicant (for all designated States except US): PRESSCO TECHNOLOGY INC. [US/US]; 29200 Aurora Road, Solon, OH 44139–1847 (US).

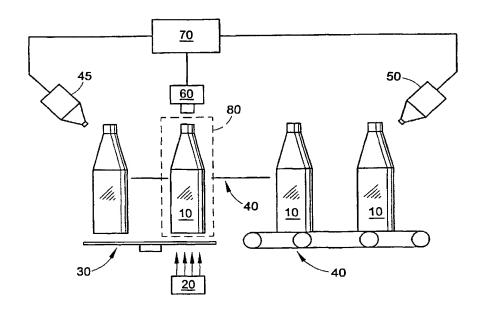
(72) Inventor; and
(75) Inventor/Applicant (for US only): CECH, Steven, D. [US/US];
670 Rock Creek Drive, Aurora, OH 44202 (US).

(74) Agent: MINNICH, Richard, J.; Fay, Sharpe, Fagan, Minnich & McKee, LLP, 7th floor, 1100 Superior Avenue, Cleveland, OH 44114-2518 (US). (81) Designated States: AE, AG, AL, AM, AT, AU, AZ, BA, BB, BG, BR, BY, CA, CH, CN, CR, CU, CZ, DE, DK, DM, DZ, EE, ES, FI, GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE, KG, KP, KR, KZ, LC, LK, LR, LS, LT, LU, LV, MA, MD, MG, MK, MN, MW, MX, NO, NZ, PL, PT, RO, RU, SD, SE, SG, SI, SK, SL, TJ, TM, TR, TT, TZ, UA, UG, US, UZ, VN, YU, ZA, ZW, ARIPO patent (GH, GM, KE, LS, MW, SD, SL, SZ, TZ, UG, ZW), Eurasian patent (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM), European patent (AT, BE, CH, CY, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU, MC, NL, PT, SE), OAPI patent (BF, BJ, CF, CG, CI, CM, GA, GN, GW, ML, MR, NE, SN, TD, TG).

Published

With international search report.

(54) Title: SYSTEM AND METHOD FOR INSPECTING THE STRUCTURAL INTEGRITY OF VISIBLY CLEAR OBJECTS



(57) Abstract

An inspection system is provided comprising at least one detection element (60) sensitive to electromagnetic radiation (20) at a wavelength wherein the object (10) to be inspected is rendered opaque by naturally occurring material molecular absorptions. As such, material defects such as cracks and voids can be detected.







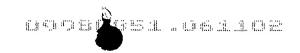


FOR THE PURPOSES OF INFORMATION ONLY

Codes used to identify States party to the PCT on the front pages of pamphlets publishing international applications under the PCT.

AL	Albania	ES	Spain	LS	Lesotho	SI	Slovenia
AM	Armenia	FI	Finland	LT	Lithuania	SK	Slovakia
AT	Austria	FR	France	LU	Luxembourg	SN	Senegal .
ΑU	Australia	GA	Gabon	LV	Latvia	SZ	Swaziland
AZ	Azerbaijan	GB	United Kingdom	MC	Monaco	TĐ	Chad
BA	Bosnia and Herzegovina	GE	Georgia	MD	Republic of Moldova	TG	Togo
BB	Barbados	GH	Ghana	MG	Madagascar	ТJ	Tajikistan
BE	Belgium	GN	Guinea	MK	The former Yugoslav	TM	Turkmenistan
BF	Burkina Faso	GR	Greece		Republic of Macedonia	TR	Turkey
BG	Bulgaria	HU	Hungary	ML	Malı	TT	Trinidad and Tobago
BJ	Benin	IE	Ireland	MN	Mongolia	UA	Ukraine
BR	Brazil	IL	Israel	MR	Mauritania	UG	Uganda
BY	Belarus	IS	Iceland	MW	Malawi	US	United States of America
CA	Canada	IT	Italy	MX	Mexico	UZ	Uzbekıstan
CF	Central African Republic	JP	Japan	NE	Niger	VN	Viet Nam
CG	Congo	KE	Kenya	NL	Netherlands	YU	Yugoslavia
CH	Switzerland	KG	Kyrgyzstan	NO	Norway	ZW	Zimbabwe
CI	Côte d'Ivoire	KP	Democratic People's	NZ	New Zealand		
CM	Cameroon		Republic of Korea	PL	Poland		
CN	China	KR	Republic of Korea	PT	Portugal		
CU	Cuba	KZ	Kazakstan	RO	Romania		
\mathbf{cz}	Czech Republic	LC	Saint Lucia	RU	Russian Federation		
DE	Germany	LI	Liechtenstein	SD	Sudan		
DK	Denmark	LK	Sri Lanka	SE	Sweden		
EE	Estonia	LR	Liberia	SG	Singapore		
ı							



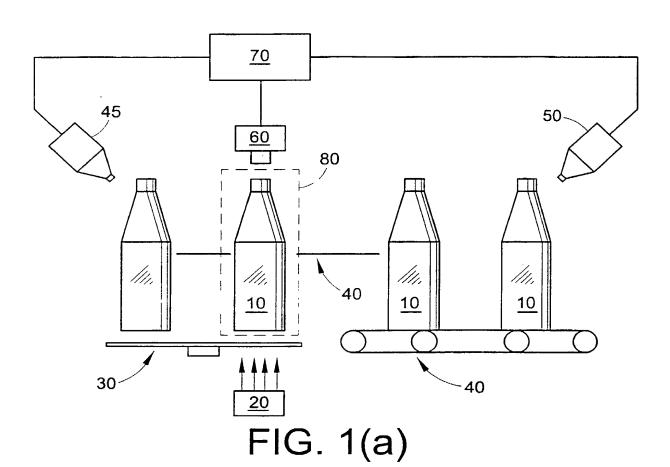


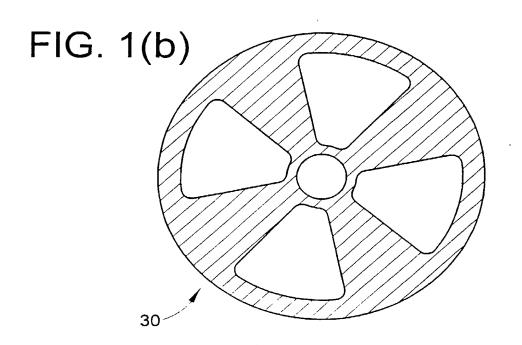
INTERNATIONAL SEARCH REPORT

International application No. PCT/US00/11308

A. CLASSIFICATION OF SUBJECT MATTER IPC(7) :B07C 5/34 US CL .356/237.1, 239.1, 239.4, 239.7, 240.1; 250/225 According to International Patent Classification (IPC) or to both national classification and IPC					
B. FIELDS SEARCHED					
Minimum documentation searched (classification system follow	ved by classification symbols)				
U.S. : 356/237.1, 239.1, 239.4, 239.7, 240.1; 250/225	,				
Documentation searched other than minimum documentation to the NONE	he extent that such documents are included in the fields searched				
Electronic data base consulted during the international search (I USPTO EAST	name of data base and, where practicable, search terms used)				
C. DOCUMENTS CONSIDERED TO BE RELEVANT					
Category* Citation of document, with indication, where a	ppropriate, of the relevant passages Relevant to claim No.				
A US 5,141,110 A (Trischan et al.) 25 entire document.	August 1992, (25/08/92) see 1-34				
A US 3,778,617 A (Calhoun) 11 Decembed document.	per 1973, (11/12/73) see entire 1-34				
Further documents are listed in the continuation of Box C	See patent family annex.				
A document defining the general state of the art which is not considered to be of particular relevance	"T" later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention				
L carlier document published on or after the international filing date *L* document which may throw doubts on priority claim(s) or which is cited to establish the publication date of another citation or other	*X" document of particular relevance, the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone				
O document referring to an oral disclosure, use, exhibition or other means	"Y" document of particular relevance, the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art				
P document published prior to the international filing date but later than the priority date claimed	*&* document member of the same patent family				
Date of the actual completion of the international search	Date of mailing of the international search report				
26 JUNE 2000	24 JUL 2000				
Name and mailing address of the ISA/US Commissioner of Patents and Trademarks Box PCT Washington, D.C. 20231	Authorized officer MICHAEL P. STAFIRA				
Facsimile No. (703) 305-3230	Telephone No. (703) 308-763				

1/3

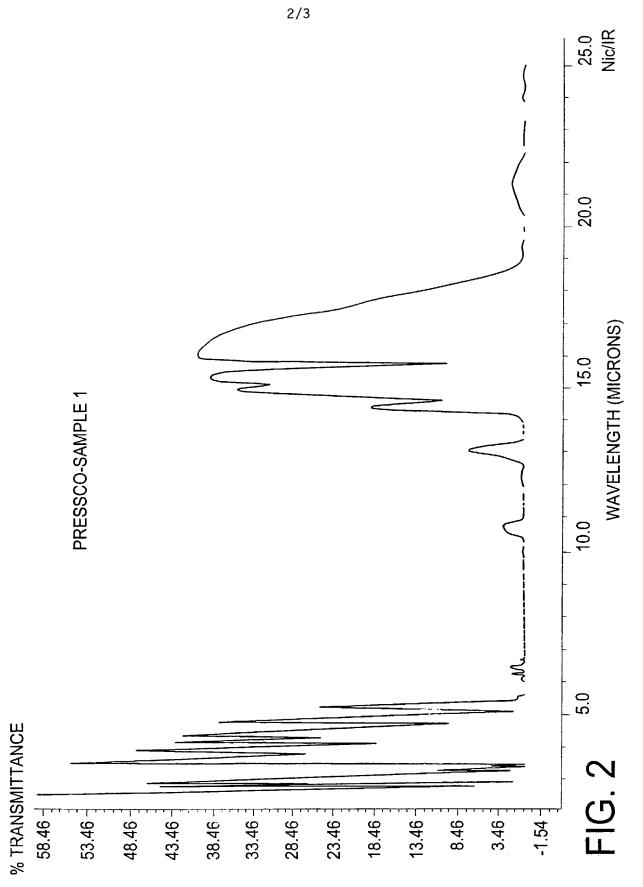




SUBSTITUTE SHEET (RULE 26)

00080851.0509/98/5 PCT/US00/11308





SUBSTITUTE SHEET (RULE 26)

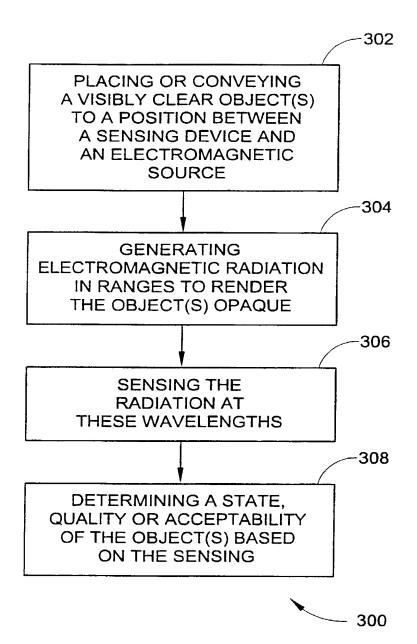
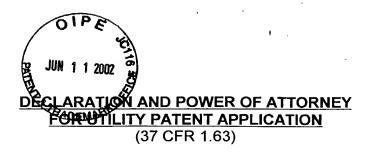


FIG. 3



As a below inventor, I hereby declare that:

My residence, mailing address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled:

SYSTEM AND METHOD FOR INSPECTING THE STRUCTURAL INTEGRITY OF VISIBLY CLEAR OBJECTS

the specification of which was filed on April 27, 2000 as United States Application Number 09/980,851.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56, including for continuation-in-part applications, material information which became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

I hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or (f), or 365(b) of any foreign application(s) for patent or inventor's certificate(s), or 365(a) of any PCT international application which designated at least one country other than the United States of America, listed below and have also identified below, by checking the box, any foreign application(s) for patent or inventor's certificate(s), or any PCT international application having a filing date before that of the application on which priority is claimed:

Prior Foreign Application Number(s)	Country	Foreign Filing Date	Priority Not Claimed	Certifie Attac YES	
PCT/US/0011308	PCT	27 April 2000			

I hereby claim the benefit under 35 U.S.C. 119(e) of United States provisional application(s) listed below.

Application Number(s)	Day/Month/Year Filed	Additional Provisional Application Numbers Listed on Supplemental Priority Data Sheet Attached
60/131,561	April 29, 1999	No

I hereby claim the benefit under Title 35, United States, § 120 of any United States application(s) or any PCT international application designating the United States of America, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application or PCT International application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information which is material to patentability as defined in Title 37, of Federal Regulations Code, § 1.56(a) which became available between the filing date of the prior application and the national or PCT international filing date of this application:

U.S. Parent Application <i>or</i> PCT Parent Number	Parent Filing Date Day/Month/Year Filed	Parent Patent Number (if applicable)	
,,,,,			

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorneys to prosecute this application and transact all business in the United States Patent and Trademark Office connected therewith.

	Mark E. Bandy, Brian G. Bembenick, Alan C. Brandt, John P. Cornely, David B. Cupar, Joseph D. Dreher, Matthew P. Dugan, Christopher B. Fagan, Patrick D. Floyd, Jude A. Fry, Steven M. Haas, Michael E. Hudzinski, Edward T. Kennedy, Richard M. Klein.	Reg. No. 35,788 Reg. No. 41,463 Reg. No. 50,218 Reg. No. 41,687 Reg. No. 47,510 Reg. No. 37,123 Reg. No. 44,663 Reg. No. 22,987 Reg. No. 39,671 Reg. No. 38,340 Reg. No. 37,841 Reg. No. 34,185 Reg. No. 48,478 Reg. No. 33,000	Sandra M. Koenig, Scott A. McCollister, James W. McKee, Richard J. Minnich, Jay F. Moldovanyi, Philip J. Moy, Timothy E. Nauman, Erik J. Overberger, Patrick R. Roche, James E. Scarbrough, Ann M. Skerry, Mark S. Svat, Anuj K. Wadhwa, Joseph F. Waters	Reg. No. 33,722 Reg. No. 33,961 Reg. No. 26,482 Reg. No. 24,175 Reg. No. 29,678 Reg. No. 31,280 Reg. No. 32,283 Reg. No. 48,556 Reg. No. 29,580 Reg. No. 47,056 Reg. No. 45,655 Reg. No. 45,655 Reg. No. 50,407 Reg. No. 50,427
	Edward T. Kennedy, Richard M. Klein, Thomas E. Kocovsky, Jr.	Reg. No. 48,478 Reg. No. 33,000 Reg. No. 28,383	Anuj K. Wadhwa, Joseph E. Waters, Jason A. Worgull,	Reg. No. 50,407 Reg. No. 50,427 Reg. No. 48,044
ı				

DIRECT ALL CORRESPONDENCE

TO:

RICHARD J. MINNICH, Esq. Fay, Sharpe, Fagan, Minnich & McKee, LLP

1100 Superior Avenue, 7th Floor Cleveland, OH 44114-2518

DIRECT TELEPHONE CALLS TO:

RICHARD J. MINNICH Telephone: 216/861-5582 Facsimile: 216/241-1666 I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both under 18 U.S.C. § 1001 and that such willful false statements may jeopardize the validity of the APPLICATION or any patent issued thereon.

Name of Sole Inventor:

Inventor's Signature:

Date:

Residence:

Country of Citizenship:

Mailing Address:

STEVEN D. CECH

670 Rock Creek Drive

Aurora, Ohio 44202, U.S.

U.S.

670 Rock Creek Drive Aurora, Ohio 44202